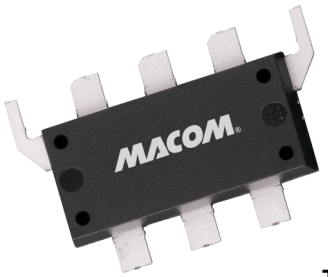
High Power RF GaN Amplifier
400 W, 48 V, 3400 - 3800 MHz

MACOM PURE CARBIDE™

MAPC-C38550-CP
Rev. V1

Features

- GaN on SiC HEMT Technology
- Designed for Asymmetrical Doherty Application
- 47.5 dBm Average Output Power
- 400 W Peak Output Power
- Input and Output Pre-matched Device
- Low Thermal Resistance
- 100% DC and RF Tested
- RoHS* Compliant



TO-248-8L

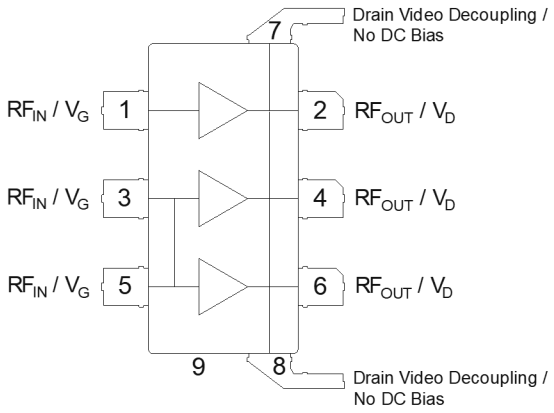
Applications

- Point-to-Point
- Infrastructure

Description

The MAPC-C38550-CP is a GaN on Silicon Carbide HEMT Amplifier designed for asymmetrical Doherty applications. The device is optimized for the frequency band of 3400 - 3800 MHz. Product is housed in an over-molded TO-package.

Functional Schematic



Typical Doherty Performance:

V_{DS} = 50 V, I_{DQm} = 280 mA, V_{GSpk}= 560 mA - 1.5 V
P_{OUT} = 47.5 dBm, T_A = 25°C
Note: Performance in MACOM Doherty Application Fixture. Single Carrier- W-CDMA Channel Bandwidth 3.84 MHz, PAR 10 dB @ 0.01% CCDF.

Frequency (MHz)	Gain (dB)	Efficiency (%)	Output PAR (dB)	ACPR (dBc)
3400	12.3	43	8.3	-32.4
3600	13.9	44.7	8.7	-32.4
3800	12.8	44.5	8.4	-32.5

Ordering Information

Part Number	Package
MAPC-C38550-CPTR1	250 pcs Tape and Reel[1]
MAPC-C38550-CPSB1	Sample Board

1. See application note AN-0004525 for Tape & Reel information.

Pin Configuration

Pin #	Pin Name	Function
1	RF_{IN} / V_G	RF Input / Gate (Main)
2	RF_{OUT} / V_D	RF Output / Drain (Main)
3,5	RF_{IN} / V_G	RF Input / Gate (Peak)
4,6	RF_{OUT} / V_D	RF Output / Drain (Peak)
7,8	VBW Lead	Drain Video Decoupling. No DC Bias
9	Flange[2]	Ground / Source

2. The flange on the package bottom must be connected to RF, DC and thermal ground.

* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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RF Electrical Characterization:

T_A = 25°C, V_{DS} = 50 V, I_{DQm} = 280 mA, V_{GSpk} = -4.4 V
Note: Performance in MACOM Doherty Application Fixture. Single Carrier- W-CDMA Channel Bandwidth 3.84 MHz, PAR 10 dB @ 0.01% CCDF.

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Power Gain	3600 MHz, P_{OUT} = 47.5 dBm	Gp	—	13.9	—	dB
Drain Efficiency	3600 MHz, P_{OUT} = 47.5 dBm	η	—	44.7	—	%
Output CCDF @ 0.01%	3600 MHz, P_{OUT} = 47.5 dBm	PAR	—	8.7	—	dB
Adjacent Channel Power	3600 MHz, P_{OUT} = 47.5 dBm	ACP	—	-32.4	—	dBc
Input Return Loss	3600 MHz, P_{OUT} = 47.5 dBm	IRL	—	-17.2	—	dB
Gain Flatness	3600 MHz, P_{OUT} = 47.5 dBm	G_F	—	1.6	—	dB
Gain Variation (-40°C to +105°C)	3600 MHz, P_{OUT} = 47.5 dBm	ΔG	—	0.02	—	dB/°C
Power Variation (-40°C to +105°C)	3600 MHz, Pulsed 10% DC	ΔP_{3dB}	—	0.002	—	dB/°C
Ruggedness: Output Mismatch	All phase angles	Ψ	VSWR =10:1, No Device Damage			

RF Electrical Test Specifications:

T_A = 25°C, V_{DS} = 50 V, I_{DQm} = 280 mA, V_{GSPK} = 560 mA - 1.3 V
Note: Performance in MACOM Doherty Production Test Fixture. Single Carrier- W-CDMA Channel Bandwidth 3.84 MHz, PAR 10 dB @ 0.01% CCDF.

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Power Gain	3800 MHz, P_{OUT} = 47.5 dBm	Gp	9.5	11.5	—	dB
Drain Efficiency	3800 MHz, P_{OUT} = 47.5 dBm	η	27	36	—	%
Output CCDF @ 0.01%	3800 MHz, P_{OUT} = 47.5 dBm	PAR	5	8.0	—	dB
Adjacent Channel Power	3800 MHz, P_{OUT} = 47.5 dBm	ACP	—	-28.5	-22	dBc

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DC Electrical Characteristics T_A = 25°C

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Main Amplifier						
Gate-Source Leakage Current	V_{GS} = -8 V, V_{DS} = 50 V	I_{GLK}	-6.5	-	-	mA
Gate-Source Leakage Current	V_{GS} = -8 V, V_{DS} = 100 V	I_{GLK}	-2.0	-	-	mA
Gate Threshold Voltage	V_{DS} = 10 V, I_D = 28 mA	V_T	-3.8	-2.8	-2.1	V
Peak Amplifier						
Gate-Source Leakage Current	V_{GS} = -8 V, V_{DS} = 50 V	I_{GLK}	-13.0	-	-	mA
Gate-Source Leakage Current	V_{GS} = -8 V, V_{DS} = 100 V	I_{GLK}	-4	-	-	mA
Gate Threshold Voltage	V_{DS} = 10 V, I_D = 56 mA	V_T	-3.8	-2.64	-2.1	V

Recommended Operating Voltages

Parameter	Test Conditions	Units	Min.	Typ.	Max.
Drain Operating Voltage	—	V	—	50	—
Gate Quiescent Voltage	V_{DS} = 48 V, I_D = 280 mA	V	-3.6	-2.85	-2.1

ESD Characteristics

Parameter	Class	Standard
Human Body Model (HBM)	Class 1B	ANSI/ESDA/JEDEC JS-001
Charge Device Model (CDM)	Class 3C	ANSI/ESDA/JEDEC JS-002

Moisture Sensitivity Level

Level	Test Standard	Package Temperature	Unit
3	IPC/JEDEC J-STD-020	260	°C

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Absolute Maximum Ratings[3,4,5,6,7]

Parameter	Absolute Maximum
Drain Source Voltage, V_{DS}	100 V
Gate Source Voltage, V_{GS}	-10 to 2 V
Drain Operating Voltage, V_{DS}	55 V
Gate Current (Main), I_G	28 mA
Gate Current (Peak), I_G	56 mA
Storage Temperature Range	-65°C to +150°C
Case Operating Temperature Range	-40°C to +125°C
Channel Operating Temperature Range, T_{CH}	-40°C to +225°C
Absolute Maximum Channel Temperature	+225°C

3. Exceeding any one or combination of these limits may cause permanent damage to this device.
4. MACOM does not recommend sustained operation above maximum operating conditions.
5. Operating at drain source voltage V_{DS} < 55V will ensure MTTF > 2.51 x 10^6 hours.
6. Operating at nominal conditions with T_{CH} ≤ 225°C will ensure MTTF > 2.51 x 10^6 hours.
7. MTTF may be estimated by the expression MTTF (hours) = A $e^{[B + C/(T+273)]}$ where T is the channel temperature in degrees Celsius., A = 1.93, B = -45.31, and C = 29,585.

Thermal Characteristics[8]

Parameter	Test Conditions	Symbol	Typical	Units
Thermal Resistance using Infrared Measurement of Die Surface Temperature	P_{DISS} = 123 W T_C=85°C,$T_{SURFACE}$ = 225°C	R_{θ}(IR)	0.99	°C/W

8. Case temperature measured using thermocouple embedded in heat-sink. Contact local applications support team for more details on this measurement.

Bias Sequencing

Bias ON

1. Ensure RF is turned off
2. Apply pinch-off voltage of -5 V to the gate
3. Apply nominal drain voltage
4. Bias gate to desired quiescent drain current
5. Apply RF

Bias OFF

1. Turn RF off
2. Apply pinch-off voltage to the gate
3. Turn-off drain voltage
4. Turn-off gate voltage

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

Gallium Nitride Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

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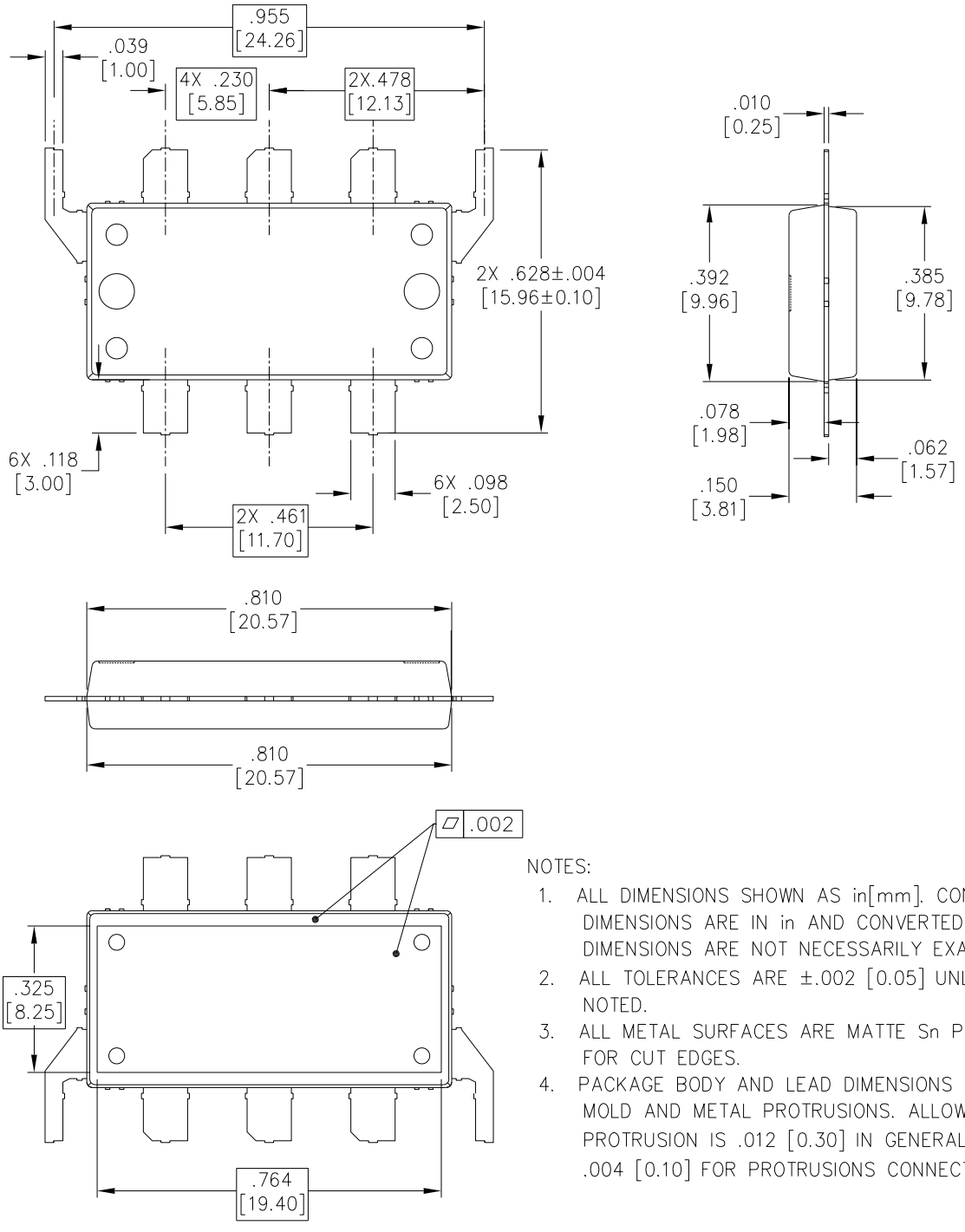
TO-248-8L Package Dimensions



NOTES:

1. ALL DIMENSIONS SHOWN AS in[mm]. CONTROLLING DIMENSIONS ARE IN in AND CONVERTED mm DIMENSIONS ARE NOT NECESSARILY EXACT.
2. ALL TOLERANCES ARE ±.002 [0.05] UNLESS OTHERWISE NOTED.
3. ALL METAL SURFACES ARE MATTE Sn PLATED EXCEPT FOR CUT EDGES.
4. PACKAGE BODY AND LEAD DIMENSIONS DO NOT INCLUDE MOLD AND METAL PROTRUSIONS. ALLOWABLE PROTRUSION IS .012 [0.30] IN GENERAL AND .004 [0.10] FOR PROTRUSIONS CONNECTED TO SOURCE

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